DISCRETE SEMICONDUCTORS

DATA SHEET



勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100v.com.tw

BAS32L High-speed diode

Product specification
Supersedes data of April 1996

1996 Sep 10





High-speed diode

BAS32L

FEATURES

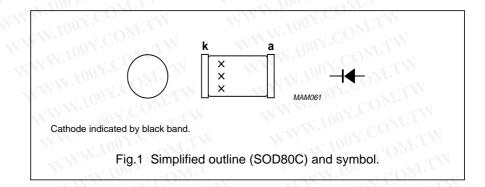
- Small hermetically sealed glass SMD package
- High switching speed: max. 4 ns
- Continuous reverse voltage: max. 75 V
- Repetitive peak reverse voltage: max. 75 V
- Repetitive peak forward current: max. 450 mA.

APPLICATIONS

- · High-speed switching
- · Fast logic applications.

DESCRIPTION

The BAS32L is a high-speed switching diode fabricated in planar technology, and encapsulated in the small hermetically sealed glass SOD80C SMD package.



LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{RRM}	repetitive peak reverse voltage	MWW. TOX.COM	-111	75	V
V _R	continuous reverse voltage	AMM.Ing A COM.	- 🛪	75	A CO
I _F	continuous forward current	see Fig.2; note 1	_	200	mA
I _{FRM}	repetitive peak forward current	M. 1007. CONT.TA	_	450	mA
I _{FSM}	non-repetitive peak forward current	square wave; T _j = 25 °C prior to surge; see Fig.4		MMM	1007.
	M. 100 T. COMIT	t = 1 μs		4	Α
	WW.100X.COM.TW	t = 1 ms	_	1	A 100
	WWW.T100Y.Com.TY	t = 1 s	TY.	0.5	A 10
P _{tot}	total power dissipation	T _{amb} = 25 °C; note 1	MIT	500	mW
T _{stg}	storage temperature	CA MAN TOON CO	-65	+200 🦠	°C
T _j	junction temperature	WWW.	ON. TOWN	200	°C

Note

1. Device mounted on an FR4 printed-circuit board.

High-speed diode

BAS32L

ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _F	forward voltage	see Fig.3	COD	I.I	
	ONITY WY	$I_F = 5 \text{ mA}$	620	750	mV
W.100X.C	WW W	I _F = 100 mA	1007	1000	mV
	COM. THE WAY	I _F = 100 mA; T _j = 100 °C	100 Y.C	930	mV
IR	reverse current	see Fig.5	· Anny.	COPY	N
MMM.10 MMM.10	COM.	V _R = 20 V	11.70	25	nA
	Dr. CONITA	V _R = 75 V	$1M_{700}$. (5)	μΑ
	OOY.COMITW WY	V _R = 20 V; T _j = 150 °C	71V+100	50	μΑ
	OOY.COM	V _R = 75 V; T _j = 150 °C	- 10	100	μΑ
V _{(BR)R}	reverse breakdown voltage	I _R = 100 μA	100	001.00	V
C _d	diode capacitance	f = 1 MHz; V _R = 0; see Fig.6	MMM.	2	pF
t _{rr}	reverse recovery time	when switched from I_F = 10 mA to I_R = 10 mA; R_L = 100 Ω ; measured at I_R = 1 mA; see Fig.7	WWW	1004.0	ns
V _{fr}	forward recovery voltage	when switched from $I_F = 50$ mA; $t_r = 20$ ns; see Fig.8	AM	2.5	VO

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-tp}	thermal resistance from junction to tie-point	M. 1001. CONT.T.	300	K/W
R _{th j-a}	thermal resistance from junction to ambient	note 1	350	K/W

Note

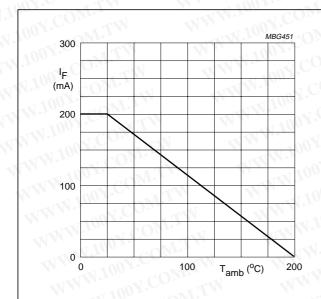
1. Device mounted on an FR4 printed-circuit board. WWW.100Y.CO

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787

Http://www. 100y. com. tw High-speed diode

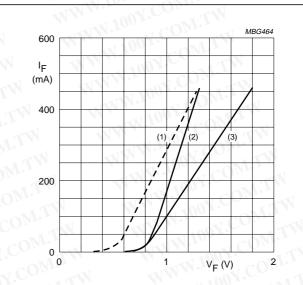
BAS32L

GRAPHICAL DATA



Device mounted on an FR4 printed-circuit board.

Maximum permissible continuous forward current as a function of ambient temperature.



- (1) $T_j = 175$ °C; typical values.
- (2) $T_j = 25$ °C; typical values.
- (3) T_i = 25 °C; maximum values.

Forward current as a function of forward voltage.

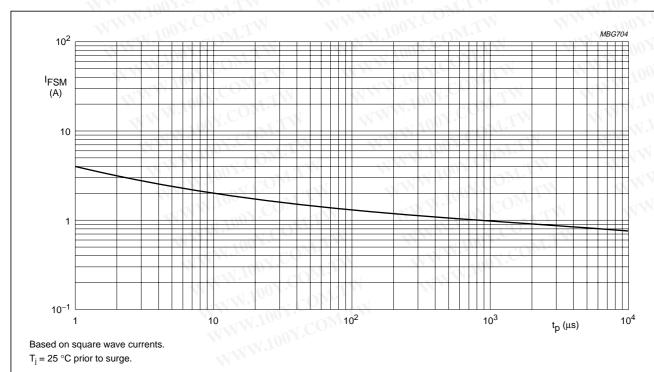
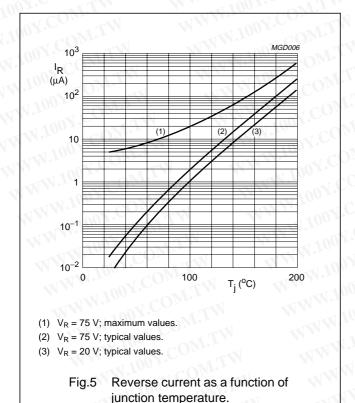


Fig.4 Maximum permissible non-repetitive peak forward current as a function of pulse duration.

High-speed diode

BAS32L

WWW.100Y.COM.TW



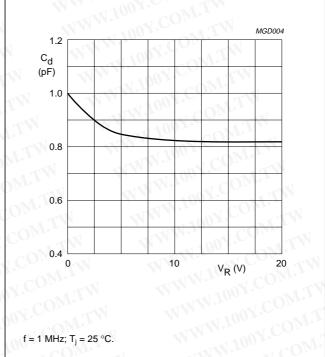
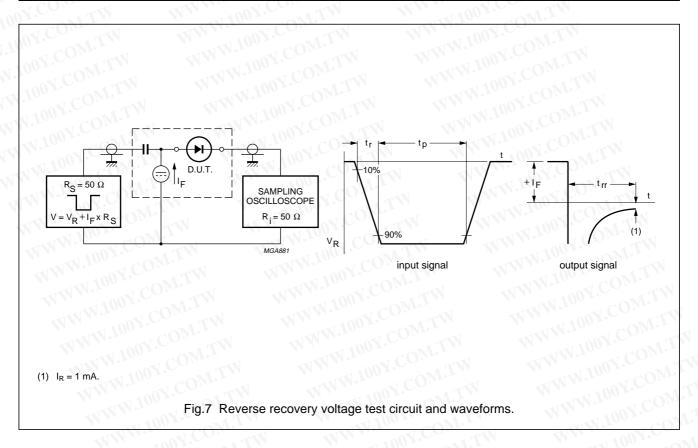
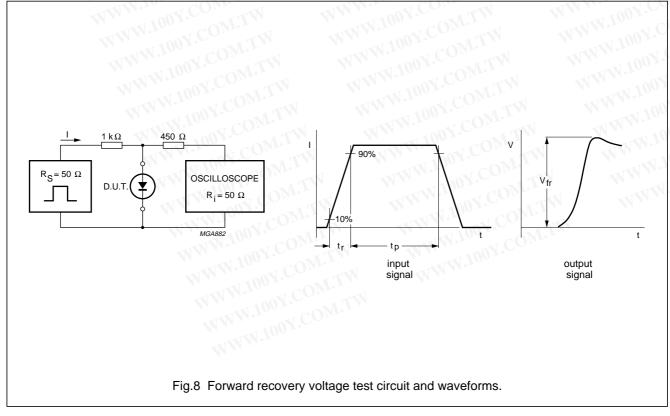


Fig.6 Diode capacitance as a function of reverse voltage; typical values.

High-speed diode

BAS32L



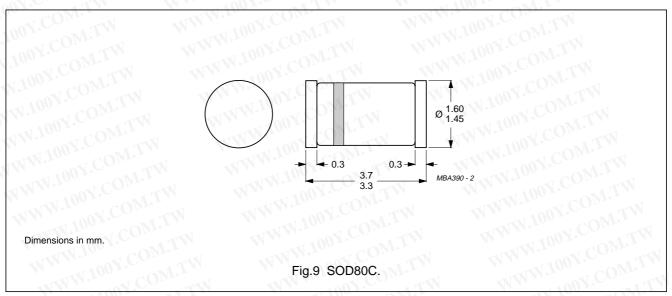


1996 Sep 10

High-speed diode

BAS32L

PACKAGE OUTLINE



DEFINITIONS

Data Sheet Status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later
Product specification	This data sheet contains final product specifications.
Limiting values	OX.CO. TW WWW.100X.COM.TW WWW.100X.C
Limiting values given are in	accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.